

Whispering gallery mode resonances from Ge micro-disks on suspended beams

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Al-Attili AZ, Kako S, Husain MK, Gardes FY, Higashitarumizu N, Iwamoto S, Arakawa Y, Ishikawa Y, Arimoto H, Oda K, Ido T and Saito S (2015) Whispering gallery mode resonances from Ge micro-disks on suspended beams. Front. Mater. 2:43. doi: 10.3389/fmats.2015.00043 Ge is considered to be one of the most promising materials for realizing full monolithic integration of a light source on a silicon (Si) photonic chip. Tensile-strain is required to convert Ge into an optical gain material and to reduce the pumping required for population inversion. Several methods of strain application to Ge are proposed in literature, of which the use of free-standing beams fabricated by micro-electro-mechanical systems (MEMS) processes are capable of delivering very high strain values. However, it is challenging to make an optical cavity within free-standing Ge beams, and here, we demonstrate the fabrication of a simple cavity while imposing tensile strain by suspension using Geon-Insulator (GOI) wafers. Ge micro-disks are made on top of suspended SiO₂ beams by partially removing the supporting Si substrate. According to Raman spectroscopy, a slight tensile strain was applied to the Ge disks through the bending of the SiO₂ beams. Whispering-Gallery-Mode (WGM) resonances were observed from a disk with a diameter of 3 μ m, consistent with the finite-domain time-difference simulations. The quality (*Q*) factor was 192, and upon increasing the pumping power, the *Q*-factor was degraded due to the red-shift of Ge direct-gap absorption edge caused by heating.

Keywords: germanium, photonics, photoluminescence, strain, micro-cavity, whispering-gallery-mode

Introduction

Transmitting uncharged photons, rather than electrons, has an advantage of reducing signal delays by eliminating capacitive coupling, reducing heating effects, and therefore total power consumption (Miller, 2009; Saito et al., 2014). The use of optical signals is responsible for a rapid growth in long-distance optical data communication technology (Brinkman et al., 2000). The demand for bandwidth is also increasing for short distance communications, and Si photonics is providing a novel solution to revolutionize the integration capability by introducing photonic circuitries within the state-of-the-art complementary metal-oxide-semiconductor (CMOS) foundries (Miller, 2009; Saito et al., 2014). Novel monolithic laser diodes will further accelerate the innovation in terms of cost and yield (Goodman et al., 1984; Saito et al., 2011, 2014). Germanium (Ge) is considered as a promising candidate (Menéndez and Kouvetakis, 2004; Liu et al., 2007, 2009, 2012a; Kurdi et al., 2010b; Liang and Bowers, 2010; Michel et al., 2010; Boucaud et al., 2013; Liu, 2014; Saito et al., 2014), being a group IV material that can acquire a positive optical gain by reducing its pseudo-direct band-gap using tensile-strain and filling the *L* valleys using heavy *n*-type doping (Menéndez and Kouvetakis, 2004; Liu et al., 2007, 2009, 2012a; Kurdi et al., 2010b; Liang and Bowers, 2010; Michel et al., 2010; Boucaud et al., 2013; Liu, 2014; Saito et al., 2014). In fact, positive optical gain (Liu et al., 2009) and lasing by optical pumping (Liu et al., 2010) and electrical pumping (Camacho-Aguilera et al., 2012) were reported in Fabry-Perot (FP) structures. More recently, lasing from a GeSn FP cavity by optical pumping at low temperature was also achieved (Wirths et al., 2015).

Light emissions from other novel cavities, including microrings (Lim et al., 2008), micro-disks (Shambat et al., 2010; Cheng et al., 2011; Ghrib et al., 2013, 2014, 2015), photonic crystals (Kurdi et al., 2008; Ngo et al., 2008; Boztug et al., 2013), and distributed brag reflectors (Saito et al., 2011) have also been investigated. Among them, Ge micro-disks are increasingly gaining attention due to their compact sizes which have advantages for high-density integration, high quality (Q) factors, enhanced spontaneous emission rate by the Purcell effect (Purcell, 1946), and efficient coupling to waveguides. Direct-gap resonances including FP (Ghrib et al., 2013, 2014, 2015) and whispering-gallery modes (WGM) (Lim et al., 2008; Shambat et al., 2010; Cheng et al., 2011; Ghrib et al., 2013, 2014, 2015) were observed from Ge micro-disks by optical (Ghrib et al., 2013) and electrical (Cheng et al., 2011) carriers injection. WGMs, which have higher Q-factors compared to FP modes, existed for certain disk diameters ranging between 2 and $4 \mu m$ from intrinsic (Lim et al., 2008; Shambat et al., 2010; Cheng et al., 2011) and doped (Ghrib et al., 2013, 2014, 2015; Xu et al., 2014) Ge. A Q-factor of 620 is reported from optically pumped intrinsic Ge micro-ring resonators (Lim et al., 2008), while Q-factors of doped Ge-on-GaAs micro-disks with reduced interface-defect density was 1350 (Ghrib et al., 2013). The degradation of Q-factor with higher pumping levels is observed, either by optical or electrical carriers injection (Shambat et al., 2010; Cheng et al., 2011). This degradation of Q-factor with pumping prevents lasing, and has to be overcome by further improvements on Ge micro-disk structures, for example, by improving crystalline qualities (Saito et al., 2011, 2014), reducing surface roughness at the edges, reducing defect density at the Ge-substrate interface (Nam et al., 2014), optimizing *n*-doping (Xu et al., 2014), and increasing tensile strain (Jain et al., 2012; Nam et al., 2013; Süess et al., 2013; Sukhdeo et al., 2014).

In particular, applying tensile strain has a significant impact on transforming Ge into an optical gain medium (Liu et al., 2007; Kurdi et al., 2010b; Suwa and Saito, 2011; Virgilio et al., 2013a,b). The tensile strain minimizes the energy difference between direct (Γ) and indirect (L) conduction band minima (de Walle, 1989; Fischetti and Laux, 1996; Wada et al., 2006), which increases the probability of electrons' dwelling in the Γ valley (Camacho-Aguilera et al., 2012; Nam et al., 2013; Süess et al., 2013). A tensile strain of 0.2% is inherent in Ge, epitaxially grown on a Si substrate due to difference in thermal expansion coefficients (Ishikawa et al., 2003, 2005; Cannon et al., 2004; Liu et al., 2005). In order to enhance the strain further, the use of buffer layers such as In_xGa_{1-x} As (Bai et al., 2008) was reported. It is also possible to employ external stressors, such as Si₃N₄ (Ghrib et al., 2012), which is a tempting approach due to its tuneablity and compatability with

standard CMOS processes; however, non-uniformity of strain in this case must be addressed (Ortolland et al., 2009; Ghrib et al., 2012, 2013, 2014; Saito et al., 2014). Moreover, suspension or micro-mechanical buckling may be used to impose even higher tensile strain (Jain et al., 2012; Nam et al., 2013; Süess et al., 2013; Sukhdeo et al., 2014). This technique involves the relaxation of a stressed layer upon releasing by under-etching. Uni-axially stressed beams are capable of delivering high strain values, up to 3.1% as reported by Süess et al. (2013). The transition from the indirect to the direct band gap structures occurs at 4.7% uni-axial tensile strain (Süess et al., 2013), and a highest uni-axial strain value of 5.7% was achieved (Sukhdeo et al., 2014). The use of freestanding beams is a promising approach to apply higher strain (Jain et al., 2012; Nam et al., 2013; Süess et al., 2013; Sukhdeo et al., 2014); however, it is not trivial to make an optical cavity on a fragile beam.

The purpose of this work is to demonstrate that it is possible to confine the optical mode in a micro-disk optical cavity, compatible with the tensile strain application in a free-standing structure. This is achieved by using Germanium-on-Insulator (GOI) wafers to fabricate Ge micro-disks on top of the buried oxide (BOX). Then, SiO_2 beams were suspended by locally removing the supporting Si substrate by alkali wet etching.

Device Structure and Fabrication

The device structure is shown in Figure 1 in which a Ge micro-disk is dry-etched on an SiO₂ beam with curved edges, which is suspended in order to release the built-in compressive stress by etching the bulk Si. Thermally grown SiO₂ has a residual compressive stress due to high growth temperatures and the difference in thermal expansion coefficient between Si and SiO₂ (Wilmsen et al., 1972). Consequently, thermally stressed SiO₂ films are capable of delivering tensile-strain upon suspension because of their tendency to deflect (Fang and Wickert, 1994; Senturia, 2001). Manipulating beam dimensions and suspension area can be implemented to control this strain (Jain et al., 2012; Nam et al., 2013; Süess et al., 2013). In order to realize this configuration, we have used commercially available intrinsic GOI wafers with a Ge/BOX thickness of 100/145 nm. The thin Ge layer was preferable to obtain higher strain values without fracturing (Boztug et al., 2013). Moreover, thinner micro-disks support lowest order modes and provide a reduced modal volume, so that they are preferable for single mode operation in the future (Gaponenko, 2010; Boztug et al., 2013).

GOI wafers were cleaned by diluted hydrofluoric (HF) and hydrochloric (HCl) acids. Then, Ge micro-disks were patterned using electron beam lithography with diameters ranging from 1 to $10 \,\mu$ m, and dry-etched using reactive-ion etching (RIE). To define the SiO₂ beams such that they hold the Ge micro-disks on top, circular holes were dry-etched into the BOX layer on both sides of the micro-disk, as shown on the top right corner of **Figure 1**. Circular-hole openings allow manipulation of suspended beam dimensions, and thus tuning the strain, such that the diameter of the holes defines the beam length (*l*) and the minimum separation between them defines the beam width (*w*). Beam design parameters, *l* and *w*, were set to 36 and 12 μ m, respectively. Before dry



suspended SiO₂ beam with curved edges and supported by SiO₂ on Si substrate. Fabrication design parameters, beam width (w), and beam length (l) are shown from a top-view in the top right corner. Axes orientation apply for the 3D sketch only.



etching, the surface was passivated by 100 nm SiO₂ deposited by plasma-enhanced chemical-vapor deposition (PECVD) at 350°C. To suspend the beams, we used 22% tetramethylammonium hydroxide (TMAH) solution to etch 10 μ m of the supporting Si substrate.

For the SiO₂ beams to be suspended, they have to be aligned with $\langle 010 \rangle$ directions (Süess et al., 2013) of the Si substrate, as shown in the optical microscopy image in **Figure 2**. Remarkably, anisotropy of TMAH etching through circular-hole openings on Si is pronounced along two directions: $\langle 110 \rangle$ at 45° relative to the beam direction $\langle 010 \rangle$, and $\langle 210 \rangle$ directions at 63.4° relative to the beam direction $\langle 010 \rangle$, as shown in **Figure 2**. After TMAH etching, beams were suspended and deflected either upwards or downwards. Direction of bending was not perfectly controlled; however, the majority of the devices were bent upward. We expect that upward bending will impose tensile strain on the top Ge micro-disks due to the longer length of the beam (Senturia, 2001).

Laser interference microscopy imaging was used to create precise three-dimensional height maps of the devices in order to examine the bending behavior of the beams and Ge disks, which



is related to the tensile strain. As shown by the laser interference microscopy image (**Figure 3**), the SiO₂ beam is bent upward with a maximum deflection of approximately 0.8 μ m. Height variations across the area of the Ge micro-disk was approximately 0.2 μ m as seen in **Figure 3**. The bending of the disk edges may contribute to strain inhomogeneity across its height (Ghrib et al., 2013, 2014, 2015).

Results and Discussion

Strain Characterization Using Raman Spectroscopy

In this section, we discuss the impact of beam suspension on Ge micro-disks by Raman spectroscopy. Tensile strain causes shrinkage of Ge band-gap (Peng et al., 2009; Süess et al., 2013; Sukhdeo et al., 2014), with a deformation rate that depends on its orientation, being either uni-axial or bi-axial (de Walle, 1989; Kurdi et al., 2010b). This tensile strain can be determined by Raman spectroscopy measurements, as tensile strain has the effect of red-shifting the Raman peak of bulk Ge (301 cm⁻¹) according to the relation $\Delta \omega = S\varepsilon$, where $\Delta \omega$ is the shift in wavenumbers, ε is the strain, and *S* is a proportionality coefficient. For bi-axial strain, *S* was reported as 390 cm⁻¹ (Capellini et al., 2013, 2014). For $\langle 001 \rangle$ uni-axial strain, *S* was reported as 152 cm⁻¹ (Peng et al., 2009; Süess et al., 2013; Sukhdeo et al., 2014).

We measured the strain using a laser with 532 nm wavelength and 2 μ m spot size. Signals were collected through 3000 lines/mm grating with an exposure time of 10 s and 50 repetitions to enhance signal-to-noise ratio. The experimental data points were fitted by a Lorentzian to estimate peak positions. First, we examined excitation power dependence to identify the impacts of heating on the additional red-shift in the Raman peak position for suspended structures. The Raman shift was found to be linear against the excitation power; the rate was -6.3×10^{-4} cm⁻¹/ μ W for a suspended 3- μ m-diameter Ge disk, while the rate was -0.18×10^{-4} cm⁻¹/ μ W for the un-patterned GOI wafer without suspension. In order to subtract the impact of heating, we linearly extrapolated the power dependence curves to find the interception of the Raman peak position.

The GOI wafer before patterning was slightly tensile-strained with a Raman shift of approximately -0.8 cm⁻¹. This shift can be



attributed to bi-axial tensile strain due to Ge on Si growth process, and the tensile strain value can then be calculated as $\varepsilon_{biaxial} \approx 0.2\%$. **Figure 4** shows the relative Raman shifts for Ge micro-disks with different diameters after suspension. We expected to apply uni-axial strain to the Ge disk by making a narrow bended beam; however, it is not straightforward to identify whether uni-axial strain overcame the original bi-axial strain. Assuming a bi-axial tensile strain is still dominant on the disks, a bi-axial tensile strain of 0.29, 0.28, and 0.35% is estimated for disks with a diameter of 1, 3, and 10 μ m, respectively. On the other hand, if the uni-axial strain is dominant, the proportionality factor *S* is smaller, so that the corresponding strain values are estimated to be larger, 0.78, 0.73, and 0.92%, respectively. In reality, both uni-axial and bi-axial components should exist, and the actual strain values should be somewhere in between the above estimations.

Uniformity of tensile strain is also critical for Ge direct-gap emission, since non-uniformity in strain would induce local variations of band-gap energies (de Walle, 1989; Kurdi et al., 2010b). Accordingly, electrons have a higher probability of dwelling regions with higher tensile strain, while converting less-strained regions into lossy mediums. As a result, the total overlap between gain regions and resonant modes may be reduced (Ghrib et al., 2013, 2014, 2015). In order to examine uniformity of strain distribution in our device, we scanned a two-dimensional Raman spectra of a 3 μ m suspended Ge disk, with a step of 200 nm. The intensity distribution of Raman peaks of the Ge disk is shown in Figure 5A, while Figure 5B shows the actual Raman-shift distribution across the top surface of the disk. The black solid and dashed contour lines specify the regions with highest Raman intensity of more than 400 counts and 350 counts, respectively. It can be concluded from this mapping that a Raman shift of -1.11 cm^{-1} (0.28% bi-axial or 0.73% uniaxial tensile strain) exists over the majority of the Ge disk area. The stress seems to be relaxed at the circumference, which may be related to deformation of the disk at the edges.

Photoluminescence and Direct-Gap Resonances

We performed finite-domain time-difference (FDTD) simulations using Lumerical FDTD software to estimate direct-gap resonances that exist in a $3 \mu m$ disk suspended on SiO₂ beam, as shown in the inset of Figure 6. We chose the diameter to be $3\,\mu\text{m}$ because WGM resonances were observed only in $3\,\mu\text{m}$ disks as will be shown below. Thicknesses of Ge and SiO₂ films are 100 and 145 nm, and refractive indexes were set to 4.2 and 1.45, respectively. We used an in-plane electric field source $(\vec{\varepsilon_{x,y}})$ assuming that only transverse-electric (TE) modes can be guided in 100 nm Ge (McCall et al., 1992; Boztug et al., 2013). The source pulse was chosen to have a Gaussian distribution centered around $1.7 \,\mu\text{m}$ to excite the modes within the direct-gap of Ge under slight tensile strain conditions. Simulation time was long enough to ensure clear visualization of resonant modes. The spectrum of the suspended 3 μ m disk is shown in **Figure 6**, with resonant peaks identified as WGMs at 1.508, 1.561, 1.626, 1.708, and 1.811 µm. Surface plots of magnetic field component perpendicular to the plane of the disk (\mathcal{H}_z) of these resonances are shown on top of **Figure 6**. From these surface plots, we can label the $TE_{m,n}$ WGMs as TE13,1, TE12,1, TE11,1, TE10,1, and TE9,1, respectively, where m is the azimuthal number (number of full wavelengths across the inner circumference of the disk) and n is the radial number (number of field maxima along the radius).

Photo-luminescence (PL) measurements were conducted at room temperature using a continuous-wave laser with a wavelength of 730 nm and approximately $2 \,\mu m$ spot size. Suspended Ge disks with diameters ranging from 1 to $10 \,\mu m$ were excited from top with 400 μ W laser power. PL spectra for different disk sizes are shown in Figure 7A, which corresponds to Ge direct-gap recombinations (Sun et al., 2009; Kurdi et al., 2010a; Saito et al., 2011, 2014; Liu et al., 2012b). Accumulation of slight tensile strain within the Ge disks, as proved by Raman measurements, causes a corresponding red-shift in PL spectra (de Walle, 1989; Süess et al., 2013; Sukhdeo et al., 2014). The measured tensile strain values contribute to a red-shift of the direct-gap up to 1630-1640 nm (de Walle, 1989; Kurdi et al., 2010b), while the additional red-shift of the PL spectra is due to heating. Sharp-peak resonances were obtained for $3 \mu m$ disks only, and these peaks are attributed to WGMs occurring at 1591.5, 1704.4, and 1809.9 nm as shown in Figure 7B. Corresponding quality factors of 67, 182, and 191.8, respectively, were determined by fitting the resonant peaks with a Lorentzian. According to FDTD simulations, we identified these peaks to be TE_{11,1}, TE_{10,1}, and TE_{9,1} WGMs, respectively. On contrary, smaller disks with 1 and 2 μ m diameters, suffered from extreme broadening in emission spectrum and no modulation by cavity resonances, were observed. This broadening can be explained by severe heating effects, due to the small disk diameters which were comparable to the spot size of the excitation laser. On the other hand, larger disks of 6, 8, and 10 μ m diameter had broad-peak resonances. As the disk size increases, number of broad-peak resonances increases and free spectral range (FSR) between them decreases. The exact identification of these peaks is not straightforward; however, these resonances have broader



FIGURE 5 | Two-dimensional Raman spectroscopy map of a suspended 3 μ m Ge disk showing: (A) Raman intensity distribution and (B) actual Raman shift across the Ge surface. The black solid and dashed contour lines specify the regions with highest Raman intensity of more than 400 and 350 counts, respectively.



peaks compared to WGMs observed in 3 μm disks, and consequently less important for monolithic operation. The reason for the absence of WGMs in larger disks would be related to the spot size of the laser (~2 μm), and only the center of the disks was excited.

Figure 7B shows PL spectra of the suspended $3 \mu m$ disk for different excitation-power conditions. As the excitation power increases, the direct-gap emission intensity of the Ge disk increases. TE_{11,1} mode is barely visible on a log-scale figure

because of its low intensity and Q-factor; presumably, it is highly affected by absorption from Ge due to its lower wavelength (Ishikawa et al., 2005; Wang et al., 2013). So, we will concentrate our discussions on TE_{10,1}, and TE_{9,1}. It was found that the intensities of TE_{10,1} and TE_{9,1} modes were proportional to $P^{2.28}$ and $P^{1.98}$, respectively, where *P* is the excitation power, as shown in **Figure 8**. This indicates that the tensile strain was not high enough to observe direct-gap characteristics. This agrees with our previous results (Al-Attili et al., 2015) in which we discussed the



FIGURE 7 | (A) Photoluminescence spectra of Ge micro-disks on suspended SiO₂ beams with different diameters ranging from 1 μ m to 10 μ m using 400 μ W excitation power, WGM are observed in the 3 μ m disk spectrum, while broad-peak resonances are observed for 6, 8, and 10 μ m disks.



quadratic $(\propto P^2)$ power dependence of emission intensities for intrinsic Ge, compared to a linear dependence $(\propto P^1)$ for *n*-doped Ge. This difference was explained by the initial consumption of injected carriers in filling the *L* valleys in the case of intrinsic Ge due to its inherent in-direct band gap character, which causes a modest increase in emission intensity with power.

Figure 9 shows the behavior of $TE_{9,1}$ and $TE_{10,1}$ *Q*-factors and resonant-peak positions as we increase the excitation power. A general trend of *Q*-factor degradation and red-shifting of

(B) Photoluminescence power-dependence of the suspended 3 μ m Ge disk. The resonant WGMs are labeled as TE_{10,1} and TE_{9,1} according to FDTD simulations. At 800 μ W pumping level, TE_{10,1} peak is invisible, while we can still observe TE_{9,1}.

resonant peaks with increased carriers' injection is evident; this agrees with the work of other groups under optical (Shambat et al., 2010; Ghrib et al., 2013, 2014, 2015) and electrical (Cheng et al., 2011) pumping. Degradation of Q-factors with pumping has two main reasons: (I) heating which effectively shrinks Ge band-gap causing a red-shift in the direct-gap absorption edge (Ishikawa et al., 2003, 2005; Cannon et al., 2004; Liu et al., 2005; Wang et al., 2013), and consequently increasing the absorption coefficient at lower wavelengths. This loss mechanism affects high-energy (short wavelength) modes (Ishikawa et al., 2005; Lim et al., 2008; Wang et al., 2013). In addition to (II) the increase in free-carrier absorption (FCA) losses due to additional photo-induced carriers (Liu et al., 2007, 2012b; Kurdi et al., 2010b; Shambat et al., 2010), this loss mechanism is pronounced for lower energy (higher wavelength) resonances which suffer higher FCA (Liu et al., 2007; Kurdi et al., 2010b; Ghrib et al., 2013). Due to the association of both factors with injected carriers' density, Q-factors of WGMs in Ge micro-disks are consequently affected by pumping levels. These excitationrelated loss mechanisms cause broadening of resonant peaks until they become undetectable at high pumping powers, as shown in Figure 7B.

Moreover, examining the different behavior of *Q*-factor degradation for different resonances according to **Figure 9**. It is obvious that up to 300 μ W, the resonant peaks at 1704.4 nm (TE_{10,1}) and 1809.9 nm (TE_{9,1}) are broadened in a similar manner. However, as we keep increasing the excitation power above 300 μ W, the



lower-wavelength mode $(TE_{10,1})$ undergoes a higher degradation rate, while the higher-wavelength mode (TE9,1) remains broadening at the same degradation rate. This can be explained as follows: at pump powers lower than 300 μ W both modes are affected by FCA, while the red-shift in the Ge direct-gap absorption edge is not enough to approach $TE_{10,1}$ yet. As we keep increasing the pump power, Ge direct-gap continues to red-shift due to heating until the direct-gap absorption totally overshadows the resonant peak of TE_{10,1} and we can no longer observe this peak at 600 μ W, as shown in Figure 7. At this stage, the higher-wavelength mode is still suffering from increasing FCA but it remains unaffected by the Ge direct-gap absorption, and we still observe this peak even at 800 μ W. This indicates that absorption due to heating is more significant than the FCA in preventing lasing. In order to avoid high injection levels and reduce absorption due to heating, higher tensile strain levels in addition to high *n*-type doping levels are required. n-type doping (Xu et al., 2014) also reduces FCA losses by allowing inversion with reduced levels of injected holes, which have a higher contribution to the total FCA compared to electrons (Liu et al., 2012b). There is a small dip in the Q-factor of $TE_{9,1}$ around the pump power of 0.3 mW (Figure 9A), followed by a slight enhancement at 0.4 mW, before it starts to decrease again. This enhancement of Q-factor would be originating from the red-shift of the direct band edge toward the longer wavelengths due to heating, causing a partial offset in the FCA.

Conclusion and Future Work

In this paper, we have proposed a configuration to apply tensile strain on Ge micro-disks by suspension of the underlying SiO_2 layer, for Ge monolithic emission purposes. We have shown that it is possible to accumulate tensile strain by using this structure. Further optimization has to be made in order to obtain higher tensile strain values. For instance, manipulating beams'

dimensions, BOX thickness, or depositing an additional stressor layer can be implemented to enhance tensile strain and reduce the lasing threshold. Uniformity of the applied strain was examined by performing a Raman scan and slight variations of strain at the disk edges were observed. PL spectra of suspended Ge disks with different diameters were discussed, and we identified sharp-peak WGMs only for the disk with the diameter of $3 \mu m$, while broad-peak resonances existed in larger disks. We found that the achieved tensile stress was not enough to observe direct-gap characteristics, and heating effects were predominant for disk diameters smaller than $3 \mu m$. Q-factors of WGMs were degraded with higher pump powers and this was related to the red-shift of the Ge direct-gap absorption edge and FCA. We also confirmed a quadratic power dependence of the emission intensity of intrinsic slightly strained Ge, which agrees with our previous results. We believe that Ge micro-disks hold great potential for future integration of low threshold CMOScompatible laser sources and building a mature photonic circuitry on-chip.

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Conflict of Interest Statement: The authors declare that the research was conducted in the absence of any commercial or financial relationships that could be construed as a potential conflict of interest.

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